



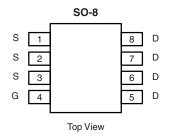
# N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)		
30	0.012 at V <sub>GS</sub> = 10 V	12.4		
	0.020 at V <sub>GS</sub> = 4.5 V	9.6		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFETs
- High Efficiency PWM Optimized
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested





Ordering Information: Si4892DY-T1-E3 (Lead (Pb)-free) Si4892DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

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N-Channel MOSFET	
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<b>ABSOLUTE MAXIMUM RATINGS</b>	$T_A = 25  ^{\circ}C$ , unle	ss otherwise i	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Ocaliana Daria Ocaza (T. 450.00)3	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	12.4	8.8	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		9.9	7.0	
Pulsed Drain Current		I <sub>DM</sub>	± 50		Α
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	2.60	1.3	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20		
Single-Pulse Avalanche Energy	L = 0.1 IIII	E <sub>AS</sub>			mJ
Mariana Barra Birata di ad	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	3.1	1.6	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C		2.0	1.0	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Mariana I langting to Ambient (MOCFFT)	t ≤ 10 s	R <sub>thJA</sub>	34	40	°C/W	
Maximum Junction-to-Ambient (MOSFET) <sup>a</sup>	Steady State		70	80		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	17	20		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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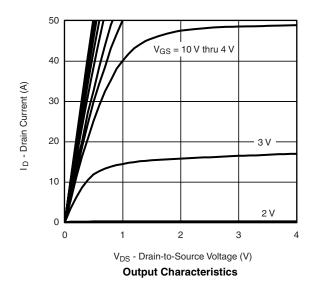
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.80			V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			1	
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			5	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α
Drain-Source On-State Resistance <sup>a</sup>	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.4 A		0.010	0.012	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 9.6 \text{ A}$		0.016	0.020	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12.4 A		27		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 2.6 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V
Dynamic <sup>b</sup>						
Total Gate Charge	$Q_g$			8.7	10.5	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 5.0 \text{ V}, I_D = 12.4 \text{ A}$		2.4		nC
Gate-Drain Charge	$Q_{gd}$			3.5		
Gate Resistance	$R_g$		0.5	1.1	1.9	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	20	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		11	20	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 6 $\Omega$		24	50	
Fall Time	t <sub>f</sub>			10	20	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	L = 2.6 A dl/dt = 100 A/vs		50	75	
Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 2.6 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$		38		nC

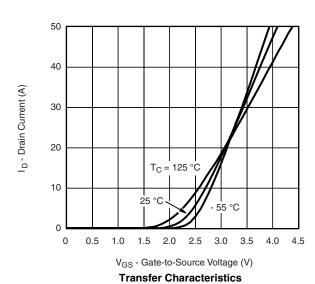
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

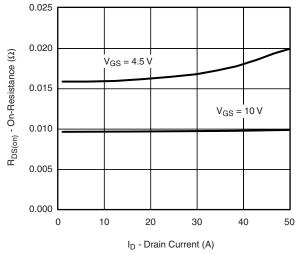


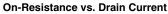


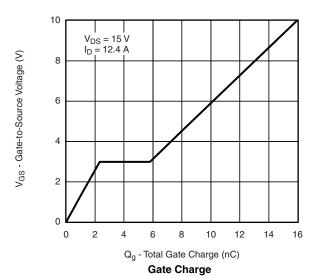


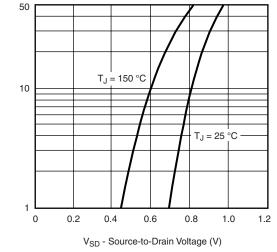


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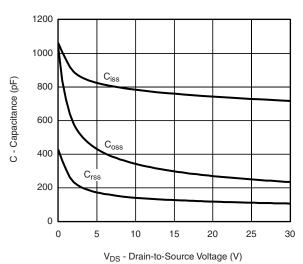




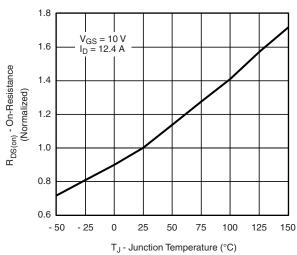




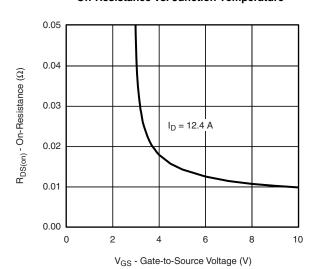
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature



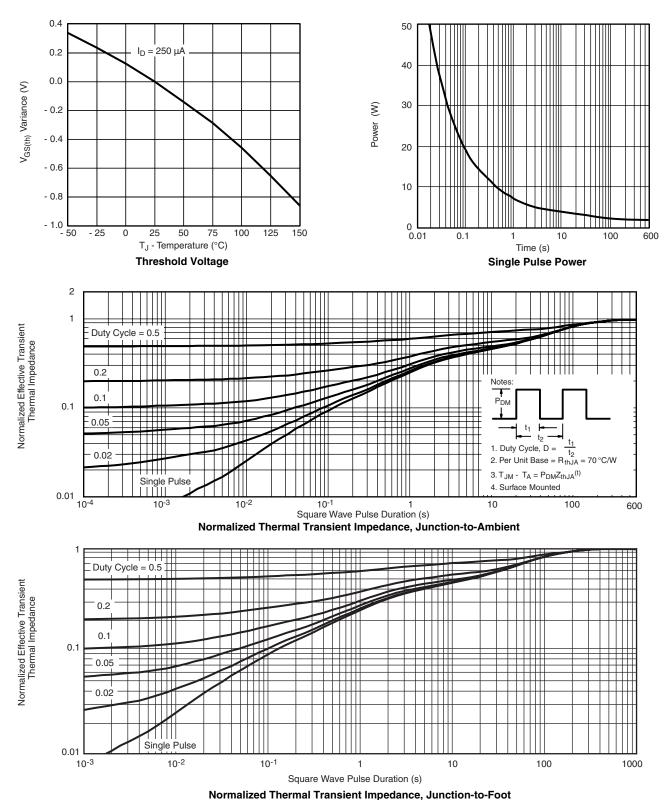
On-Resistance vs. Gate-to-Source Voltage

Is - Source Current (A)

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